

Photon Coupled Isolator MCS21, MCS2401

GaAs Infrared Emitting Diode & Light Activated SCR

The GE Solid State MCS21 and MCS2401 consist of a gallium arsenide, infrared emitting diode coupled with a light activated silicon controlled rectifier in a dual-in-line package. These devices are also available in Surface-Mount packaging.

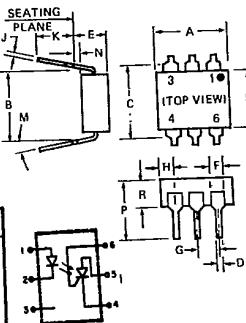
- Covered under U.L. component recognition program,
reference file E51868

absolute maximum ratings

INFRARED EMITTING DIODE	
Power Dissipation	*100 milliwatts
Forward Current (Continous)	60 millamps
Forward Current (Peak)	1 ampere
(100μsec 1% duty cycle)	
Reverse Voltage	3 volts
*Derate 1.33mW/°C above 25°C ambient.	

PHOTO-SCR

Off-State and Reverse Voltage	MCS21	200	volts
	MCS2401	400	volts
Peak Reverse Gate Voltage		6	volts
Direct On-State Current	300	millamps	
Surge (non-rep) On-State Current	10	amps	
Peak Gate Current	10	millamps	
Output Power Dissipation	**400	milliwatts	
**Derate 5.3mW/°C above 25°C ambient.			



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	8.38	8.69	.330	.350	1
B	—	7.62 REF	.300 REF	—	2
C	—	8.64	—	.340	
D	—	406	.016	.020	3
E	—	—	.050	.070	
F	—	1.01	.040	.070	
G	—	2.28	.090	.110	
H	—	2.16	—	.085	4
I	—	203	.008	.012	
J	—	2.54	.100	.15	
K	—	—	.015	.015	
M	—	15	—	—	
N	—	.381	—	.375	
P	—	9.53	—	—	
R	—	3.43	.115	.135	
S	6.10	6.86	.240	.270	

NOTES
 1. INSTALLED POSITION LEAD CENTERS.
 2. OVERALL INSTALLED DIMENSION
 3. THESE MEASUREMENTS ARE MADE FROM THE
 SEATING PLANE. 4. FOUR PLACES

TOTAL DEVICE

Storage Temperature Range — 55°C to 150°C
 Operating Temperature Range — 55°C to 100°C
 Soldering Temperature (1/16" from case, 10 seconds) 260°C
 Total Device Dissipation 450 milliwatts
 Linear Derating Factor (above 25°C) 6.0mW/°C
 Surge Isolation Voltage (Input to Output).
 4000 V_(peak) 3000 V_(RMS)
 Steady-State Isolation Voltage (Input to Output).
 3500 V_(peak) 2500V_(RMS)

individual electrical characteristics (25°C) (unless otherwise specified)

INFRARED EMITTING DIODE	TYP.	MAX.	UNITS	PHOTO-SCR	MIN.	MAX.	UNITS	
Forward Voltage V_F ($I_F = 20\text{mA}$)	1.1	1.5	V	Peak Off-State Voltage — V_{DM} $R_{GK} = 10\text{K}\Omega$, $T_A = 100^\circ\text{C}$, $I_D = 150\mu\text{A}$	MCS21	200	—	V
				MCS2401	400	—	V	
Reverse Current I_R ($V_R = 3\text{V}$)	—	10	μA	Peak Reverse Voltage — V_{RM} $(T_A = 100^\circ\text{C}, I_R = 150\mu\text{A})$	MCS21	200	—	V
				MCS2401	400	—	V	
Capacitance ($V = 0$, $f = 1\text{MHz}$)	50	—	pF	On-State Voltage — V_T ($I_T = 100\text{mA}$)	MCS21	—	1.3	V
				MCS2401	—	—		
				Off-State Current — I_D ($V_D = 200\text{V}, I_F = 0, R_{GK} = 27\text{K}\Omega$)	MCS21	—	2	μA
				MCS2401	—	2	μA	
				Off-State Current — I_D ($V_D = 400\text{V}, I_F = 0, R_{GK} = 27\text{K}\Omega$)	MCS21	—	2	μA
				MCS2401	—	2	μA	
				Reverse Current — I_R ($V_R = 200\text{V}, I_F = 0$)	MCS21	—	2	μA
				MCS2401	—	2	μA	
				Reverse Current — I_R ($V_R = 400\text{V}, I_F = 0$)	MCS21	—	2	μA
				MCS2401	—	500	μA	
				Holding Current — I_H ($V_{FX} = 50\text{V}, R_{GK} = 27\text{K}\Omega$)	—	—		

coupled electrical characteristics (25°C)

Input Current to Trigger	$V_{AK} = 50\text{V}$, $R_{GK} = 10\text{K}\Omega$	I_{FT}	MIN.	MAX.	UNITS
	$V_{AK} = 100\text{V}$, $R_{GK} = 27\text{K}\Omega$	I_{FT}	.5	11	milliamps
Isolation Resistance (Input to Output)	$V_{IO} = 500\text{V}_{DC}$	r_{io}	100	—	milliamps
Turn-On Time — $V_{AK} = 50\text{V}$, $I_F = 30\text{mA}$, $R_{GK} = 10\text{K}\Omega$, $R_L = 200\Omega$		t_{on}	—	50	gigaohms
Coupled dv/dt, Input to Output			500	—	microseconds
Input to Output Capacitance (Input to Output Voltage = 0, $f = 1\text{MHz}$)			—	2	volts/microsec.
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VDE Approved to 0883/6.80 0110b Certificate # 35025

TYPICAL CHARACTERISTICS

T-41-87

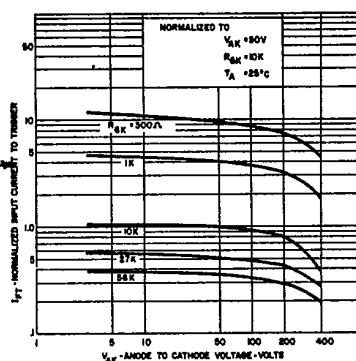


FIGURE 1. INPUT CURRENT TO TRIGGER VS. ANODE-CATHODE VOLTAGE

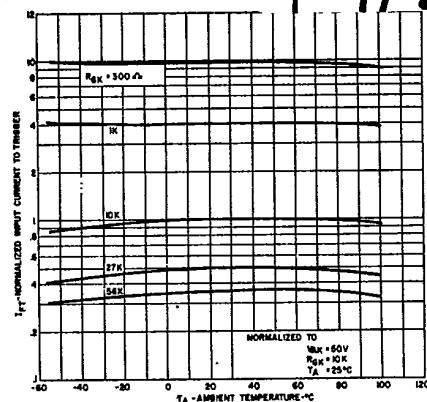


FIGURE 2. INPUT CURRENT TO TRIGGER VS. TEMPERATURE

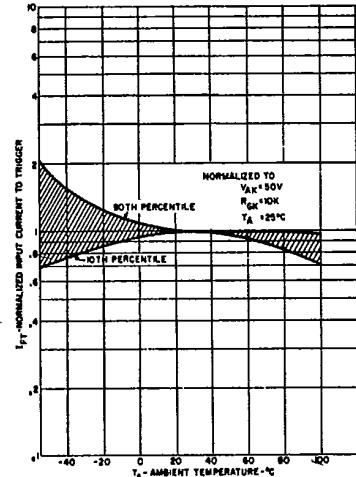


FIGURE 3. INPUT CURRENT TO TRIGGER DISTRIBUTION VS. TEMPERATURE

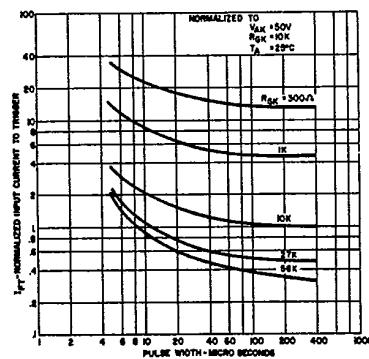


FIGURE 4. INPUT CURRENT TO TRIGGER VS. PULSE WIDTH

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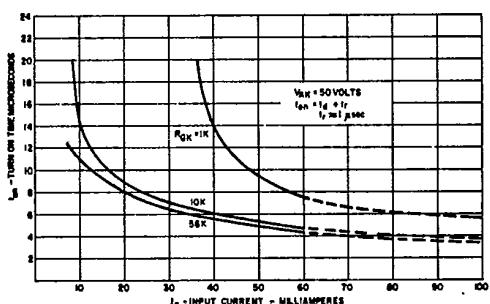
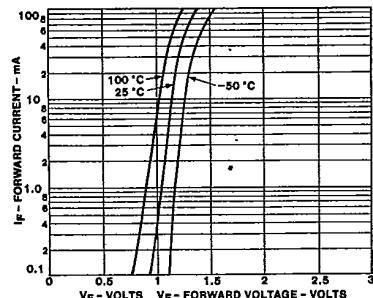


FIGURE 5. TURN-ON TIME VS. INPUT CURRENT

FIGURE 6. INPUT CHARACTERISTICS
 I_F VS. V_F